BDV65B (NPN), **BDV64B (PNP)**

Complementary Silicon Plastic Power Darlingtons

... for use as output devices in complementary general purpose amplifier applications.

- High DC Current Gain HFE = 1000 (min.) @ 5 Adc
- Monolithic Construction with Built-in Base Emitter Shunt Resistors
- Pb-Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Collector-Emitter Voltage	V_{CEO}	100	Vdc
Collector-Base Voltage	V _{CB}	100	Vdc
Emitter-Base Voltage	V _{EB}	5.0	Vdc
Collector Current – Continuous – Peak	I _C	10 20	Adc
Base Current	Ι _Β	0.5	Adc
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	125 1.0	W W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	−65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.0	°C/W

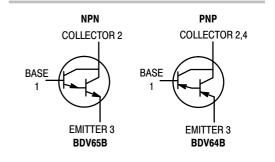
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

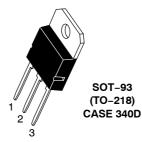


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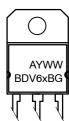
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10 AMPERE DARLINGTON **COMPLEMENTARY SILICON POWER TRANSISTORS** 60-80-100-120 VOLTS, **125 WATTS**





MARKING DIAGRAM



= Assembly Location

= Year WW = Work Week = Pb-Free Package BDV6xB = Device Code x = 4 or 5

ORDERING INFORMATION

Device	Package	Shipping
BDV65B	SOT-93	30 Units / Rail
BDV65BG	SOT-93 (Pb-Free)	30 Units / Rail
BDV64B	SOT-93	30 Units / Rail
BDV64BG	SOT-93 (Pb-Free)	30 Units / Rail

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

BDV65B (NPN), BDV64B (PNP)

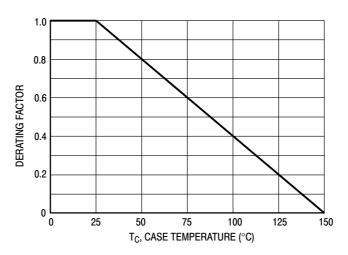
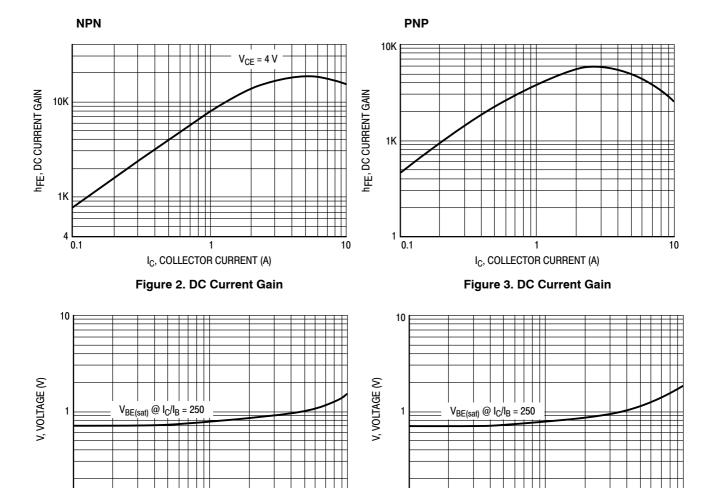


Figure 1. Power Derating

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Max	Unit	
OFF CHARACTERISTICS					
Collector–Emitter Sustaining Voltage (1) (I _C = 30 mAdc, I _B = 0)	V _{CEO(sus)}	100	_	Vdc	
Collector Cutoff Current $(V_{CE} = 50 \text{ Vdc}, I_B = 0)$		-	1.0	mAdc	
Collector Cutoff Current $(V_{CB} = 100 \text{ Vdc}, I_E = 0)$	I _{CBO}	-	0.4	mAdc	
Collector Cutoff Current $(V_{CB} = 50 \text{ Vdc}, I_E = 0, T_C = 150^{\circ}\text{C})$	I _{CBO}	-	2.0	mAdc	
Emitter Cutoff Current $(V_{BE} = 5.0 \text{ Vdc}, I_C = 0)$	I _{EBO}	-	5.0	mAdc	
ON CHARACTERISTICS					
DC Current Gain (I _C = 5.0 Adc, V _{CE} = 4.0 Vdc)	h _{FE}	1000	_	-	
Collector–Emitter Saturation Voltage $(I_C = 5.0 \text{ Adc}, I_B = 0.02 \text{ Adc})$	V _{CE(sat)}	-	2.0	Vdc	
Base–Emitter Saturation Voltage (I _C = 5.0 Adc, V _{CE} = 4.0 Vdc)	V _{BE(on)}	-	2.5	Vdc	

BDV65B (NPN), BDV64B (PNP)



0.1 - 0.1

10

I_C, COLLECTOR CURRENT (A)

Figure 4. "On" Voltages

0.1 -

Figure 5. "On" Voltages

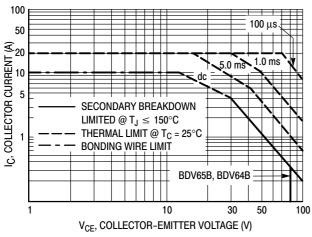


Figure 6. Active Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_C – V_{CE} limits of the transistor that must be observed for reliable operation i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

I_C, COLLECTOR CURRENT (A)

10

The data of Figure 6 is based on $T_{J(pk)} = 150^{\circ} C$, T_{C} is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \le 150^{\circ} C$. $T_{J(pk)}$ may be calculated from the data in Figure 7. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

BDV65B (NPN), BDV64B (PNP)

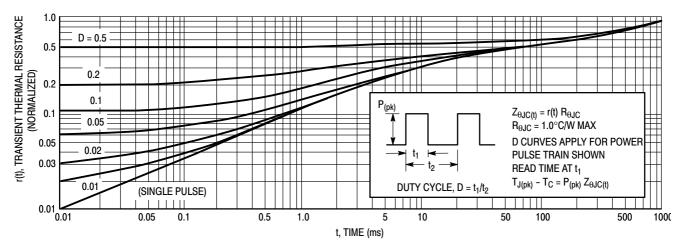
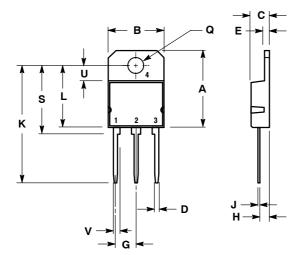


Figure 7. Thermal Response

PACKAGE DIMENSIONS

SOT-93 (TO-218) CASE 340D-02 ISSUE E



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α		20.35		0.801
В	14.70	15.20	0.579	0.598
С	4.70	4.90	0.185	0.193
D	1.10	1.30	0.043	0.051
Е	1.17	1.37	0.046	0.054
G	5.40	5.55	0.213	0.219
Н	2.00	3.00	0.079	0.118
J	0.50	0.78	0.020	0.031
K	31.00 REF		1.220 REF	
L		16.20		0.638
Q	4.00	4.10	0.158	0.161
S	17.80	18.20	0.701	0.717
U	4.00 REF		0.157 REF	
٧	1.75 REF		0.069	

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